



NEED TO SHRINK THAT PACKAGE?

Put your chip packaging on a diet. IMI's WLP technology enables production of the smallest flip chip devices made today.

In fact, IMI can put your entire device packaging program on a diet. ITAR, DOD, Medical, Aerospace, Automotive...no matter what the challenges, IMI's wafer bumping and packaging expertise can deliver shorter time to market, increase yields and lower total program costs.

- **U.S. based.**
- **ITAR registered and MIL qualified.**
- **IP stays confidential.**
- **Prototype, low volume thru scalable and volume production.**
- **Hi-Rel specifications, fine pitch and void-free proven materials for the most demanding packaging applications.**

No other domestic supplier can match IMI's level of capability and consistency in wafer bumping and WLP services.

***It's time to get your device program in shape and become more competitive.
Call IMI today at 856.616.0051 to discuss your specific wafer bumping and WLP needs.
Or visit us at www.imi-corp.com.***

IMI

INTERNATIONAL MICRO INDUSTRIES
North America's Center for Wafer Bumping Excellence™

1951 OLD CUTHBERT ROAD • BUILDING 404 • CHERRY HILL, NJ 08034 • WWW.IMI-CORP.COM • 856.616.0051

ITAR REGISTERED



GET YOUR WAFER BUMPING DONE IN THE FAR EAST...

NEW JERSEY

That's right, New Jersey.

Ask yourself these questions and see if it doesn't make sense...

- Are you concerned about confidentiality and IP protection?*
- Looking for a single source to manage R&D all the way through scalable production?*
- How about logistics and delivery issues?*
- Need a MIL-qualified domestic resource for DOD and Homeland Security contracts?*
- Just plain tired of 12+ hours on a jet?*

International Micro Industries, headquartered in the heart of Jersey for over 35 years, is your single-source solution for high quality wafer bumping and WLP services – from initial R&D to finished product. IMI caters to extreme hi-reliability specifications, fine pitch, void-free and exotic material needs for the most demanding DOD, medical and automotive applications. We offer completely scalable production from single unit to high volume. Most importantly, IMI protects your intellectual property securely while getting you to market faster with end-to-end development and production – all in-house – in New Jersey.

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